



PHOTOCOUPLER PS2561B-1,PS2561BL-1 PS2561BL1-1,PS2561BL2-1

DIP PHOTOCOUPLER OPERATING AMBIENT TEMPERATURE 110°C

–NEPOC Series–

DESCRIPTION

The PS2561B-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor.

The PS2561B-1 is in a plastic DIP (Dual In-line Package) and the PS2561BL-1 is lead bending type (Gull-wing) for surface mount.

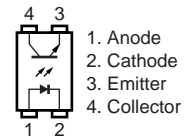
The PS2561BL1-1 is lead bending type for long creepage distance.

The PS2561BL2-1 is lead bending type for long creepage distance (Gull-wing) for surface mount.

FEATURES

- ★ • Operating ambient temperature: 110°C
- High Isolation voltage (BV = 5 000 Vr.m.s.)
- High collector to emitter voltage ($V_{CE0} = 80\text{ V}$)
- High current transfer ratio (CTR = 200% TYP.)
- High-speed switching ($t_r = 3\ \mu\text{s}$ TYP., $t_f = 5\ \mu\text{s}$ TYP.)
- Ordering number of taping product: PS2561BL-1-E3, E4, F3, F4
: PS2561BL2-1-E3, E4
- Pb-Free product
- ★ • Safety standards
 - UL approved: File No. E72422
 - CSA approved: No. CA 101391
 - BSI approved: No. 7112/7420
 - SEMKO approved: No. 408808
 - NEMKO approved: No. P04202822
 - DEMKO approved: No. 312926
 - FIMKO approved: No. FI 21008
 - DIN EN60747-5-2 (VDE0884 Part2) approved: No. 40008862 (Option)

PIN CONNECTION (Top View)



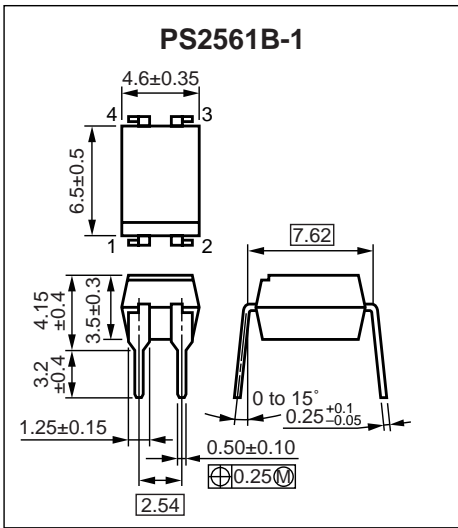
APPLICATIONS

- Power supply
- Telephone/FAX.
- FA/OA equipment
- Programmable logic controller

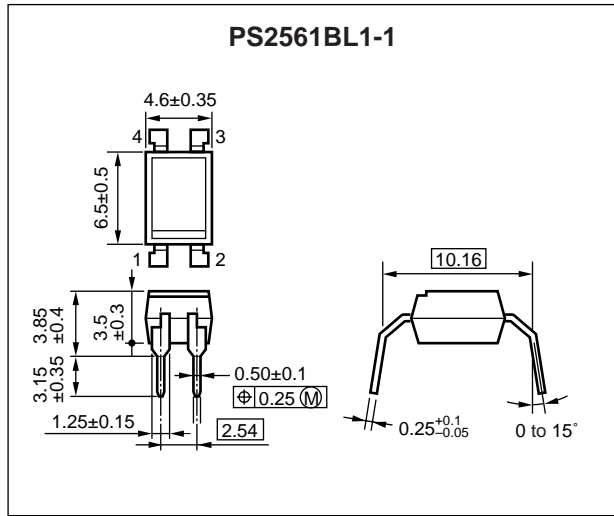
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★ **PACKAGE DIMENSIONS (UNIT : mm)**

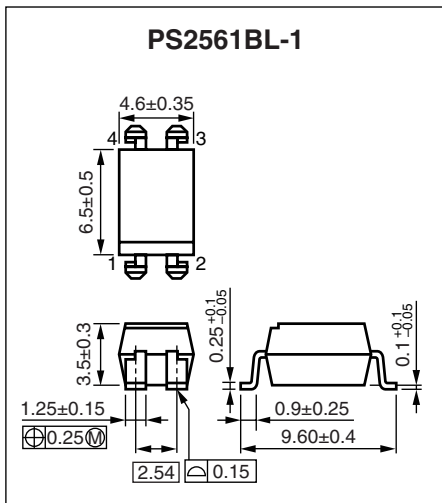
DIP Type



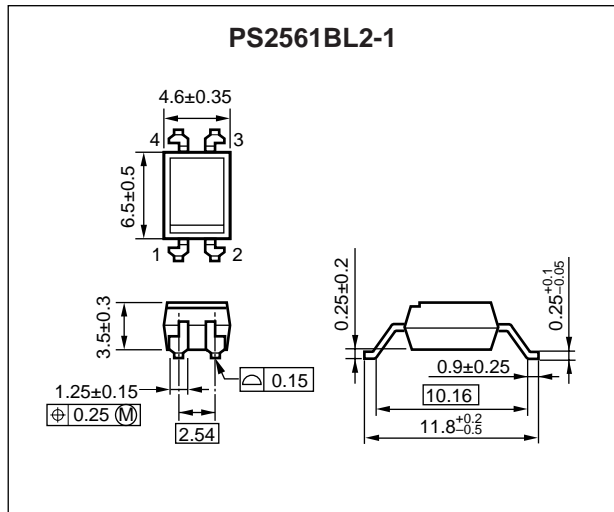
Long Creepage Distance



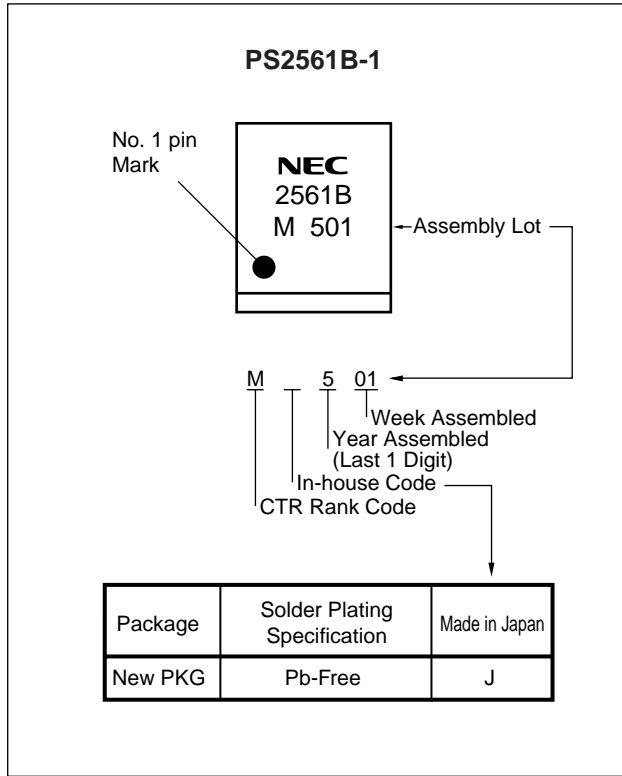
Lead Bending Type



Long Creepage Distance (Gull-Wing)



★ MARKING EXAMPLE



★ **ORDERING INFORMATION**

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS2561B-1	PS2561B-1-A	Pb-Free	Magazine case 100 pcs	Standard products (UL, CSA, BSI, NEMKO, DEMKO, SEMKO, FIMKO approved)	PS2561B-1
PS2561BL-1	PS2561BL-1-A		Embossed Tape 1 000 pcs/reel		
PS2561BL1-1	PS2561BL1-1-A				
PS2561BL2-1	PS2561BL2-1-A				
PS2561BL-1-E3	PS2561BL-1-E3-A				
PS2561BL-1-E4	PS2561BL-1-E4-A		Embossed Tape 2 000 pcs/reel		
PS2561BL-1-F3	PS2561BL-1-F3-A				
PS2561BL-1-F4	PS2561BL-1-F4-A		Embossed Tape 1 000 pcs/reel		
PS2561BL2-1-E3	PS2561BL2-1-E3-A				
PS2561BL2-1-E4	PS2561BL2-1-E4-A		Magazine case 100 pcs		
PS2561B-1-V	PS2561B-1-V-A				
PS2561BL-1-V	PS2561BL-1-V-A				
PS2561BL1-1-V	PS2561BL1-1-V-A				
PS2561BL2-1-V	PS2561BL2-1-V-A				
PS2561BL-1-V-E3	PS2561BL-1-V-E3-A			Embossed Tape 1 000 pcs/reel	
PS2561BL-1-V-E4	PS2561BL-1-V-E4-A				
PS2561BL-1-V-F3	PS2561BL-1-V-F3-A			Embossed Tape 2 000 pcs/reel	
PS2561BL-1-V-F4	PS2561BL-1-V-F4-A				
PS2561BL2-1-V-E3	PS2561BL2-1-V-E3-A			Embossed Tape 1 000 pcs/reel	
PS2561BL2-1-V-E4	PS2561BL2-1-V-E4-A				

*1 For the application of the Safety Standard, following part number should be used.

★ **ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)**

Parameter		Symbol	Ratings	Unit
Diode	Reverse Voltage	V _R	6	V
	Forward Current (DC)	I _F	40	mA
	Power Dissipation Derating	ΔP _D /°C	1.5	mW/°C
	Power Dissipation	P _D	150	mW
	Peak Forward Current ^{*1}	I _{FP}	1	A
Transistor	Collector to Emitter Voltage	V _{CEO}	80	V
	Emitter to Collector Voltage	V _{ECO}	7	V
	Collector Current	I _C	50	mA
	Power Dissipation Derating	ΔP _C /°C	1.5	mW/°C
	Power Dissipation	P _C	150	mW
Isolation Voltage ^{*2}		BV	5 000	Vr.m.s.
Operating Ambient Temperature		T _A	-55 to +110	°C
Storage Temperature		T _{stg}	-55 to +150	°C

*1 PW = 100 μs, Duty Cycle = 1%

*2 AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.

Pins 1-2 shorted together, 3-4 shorted together.

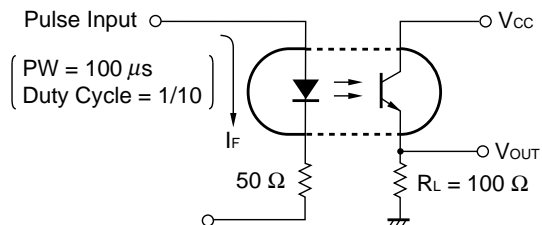
★ ELECTRICAL CHARACTERISTICS (T_A = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 10 mA		1.17	1.4	V
	Reverse Current	I _R	V _R = 5 V			5	μA
	Terminal Capacitance	C _t	V = 0 V, f = 1.0 MHz		50		pF
Transistor	Collector to Emitter Dark Current	I _{CEO}	V _{CE} = 48 V, I _F = 0 mA			100	nA
Coupled	Current Transfer Ratio (I _c /I _F) ^{*1}	CTR	I _F = 5 mA, V _{CE} = 5 V	100	200	400	%
			I _F = 1 mA, V _{CE} = 5 V	50	100		
	Collector Saturation Voltage	V _{CE(sat)}	I _F = 10 mA, I _c = 2 mA			0.3	V
	Isolation Resistance	R _{I-O}	V _{I-O} = 1.0 kV _{DC}	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1.0 MHz		0.5		pF
	Rise Time ^{*2}	t _r	V _{CC} = 10 V, I _c = 2 mA, R _L = 100 Ω		3		μs
	Fall Time ^{*2}	t _f			5		

*1 CTR rank

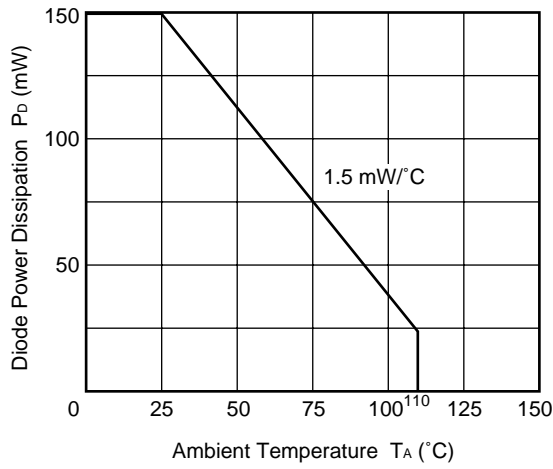
CTR Rank	CTR (%)	Conditions
Q	100 to 200	I _F = 5 mA, V _{CE} = 5 V
	50 and larger	I _F = 1 mA, V _{CE} = 5 V
W	130 to 260	I _F = 5 mA, V _{CE} = 5 V
	70 and larger	I _F = 1 mA, V _{CE} = 5 V
D	100 to 300	I _F = 5 mA, V _{CE} = 5 V
	50 and larger	I _F = 1 mA, V _{CE} = 5 V
L	200 to 400	I _F = 5 mA, V _{CE} = 5 V
	100 and larger	I _F = 1 mA, V _{CE} = 5 V
N	100 to 400	I _F = 5 mA, V _{CE} = 5 V
	50 and larger	I _F = 1 mA, V _{CE} = 5 V

*2 Test circuit for switching time

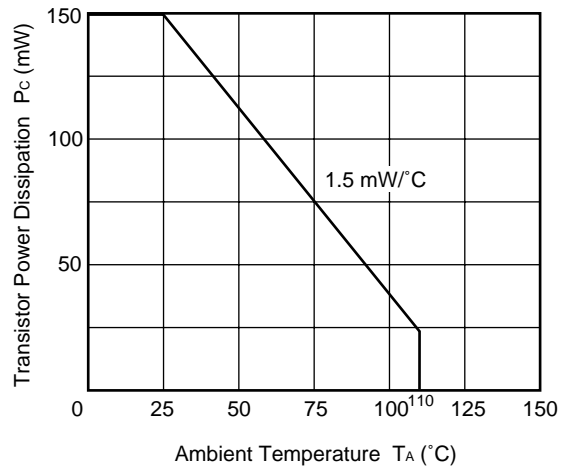


★ TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified)

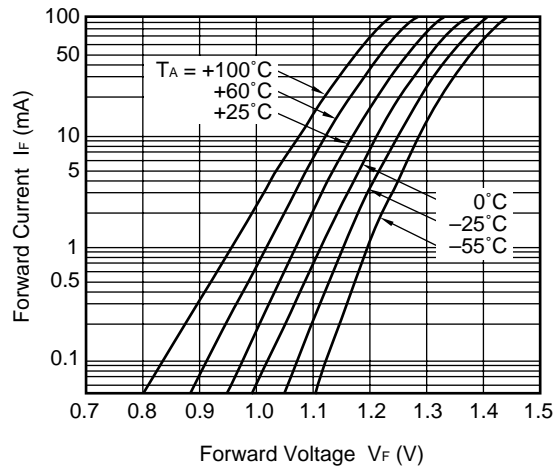
DIODE POWER DISSIPATION vs. AMBIENT TEMPERATURE



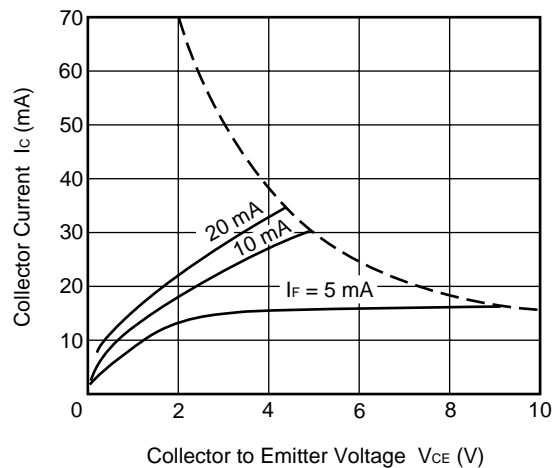
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



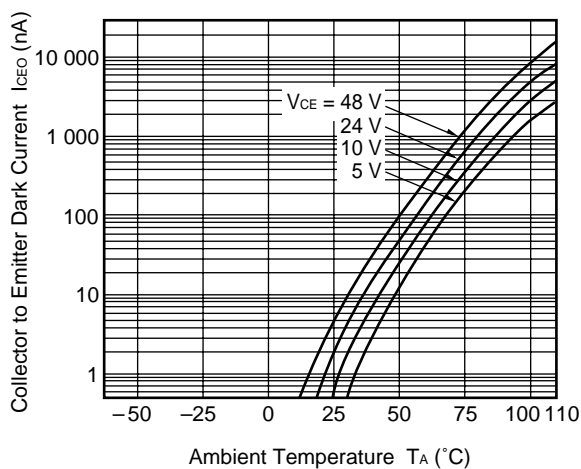
FORWARD CURRENT vs. FORWARD VOLTAGE



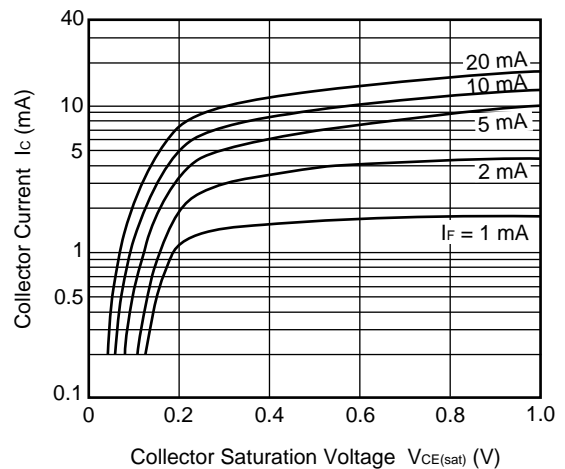
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE

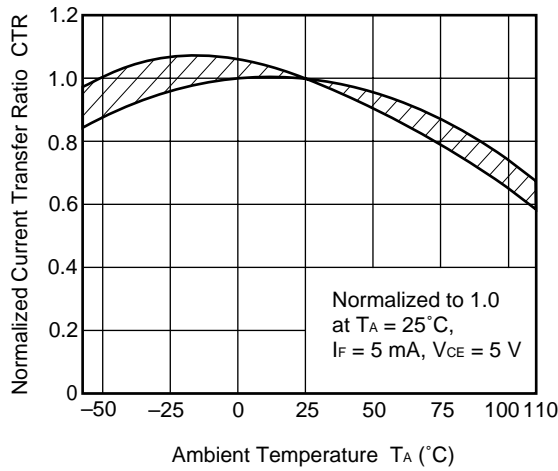


COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE

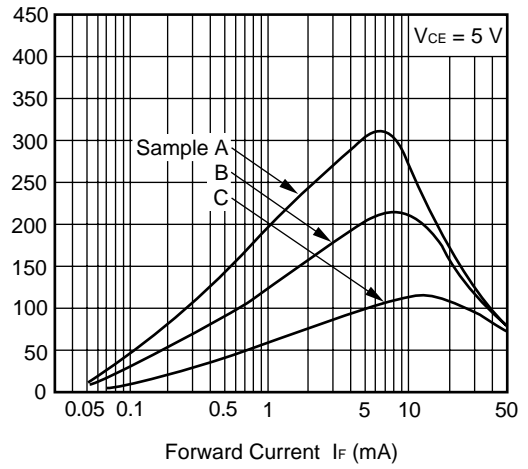


Remark The graphs indicate nominal characteristics.

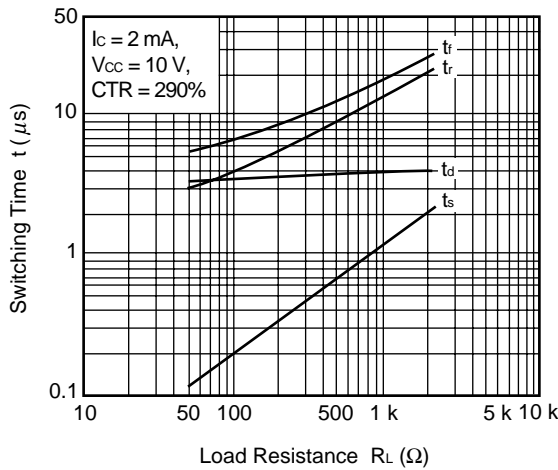
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



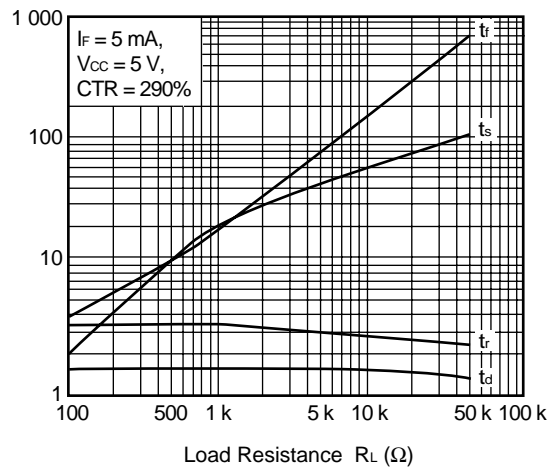
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



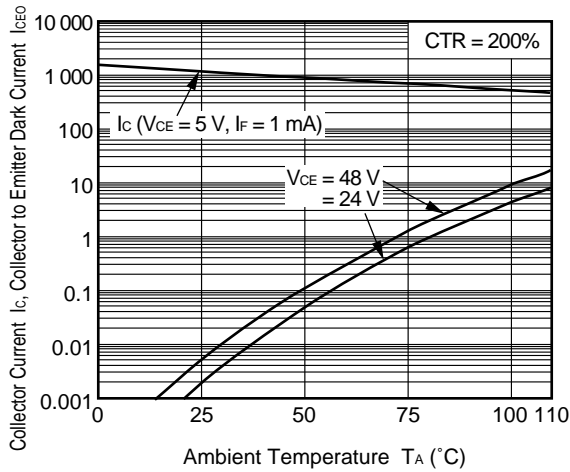
SWITCHING TIME vs. LOAD RESISTANCE



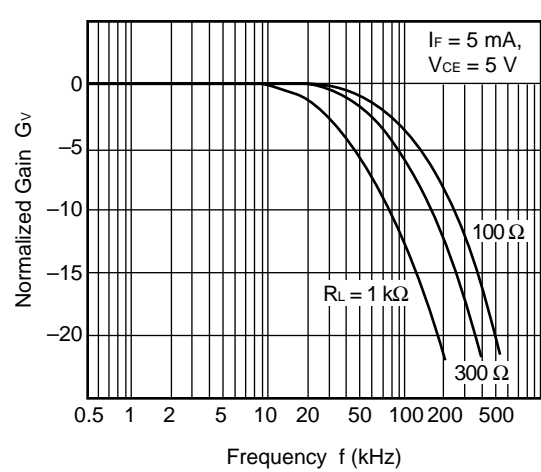
SWITCHING TIME vs. LOAD RESISTANCE



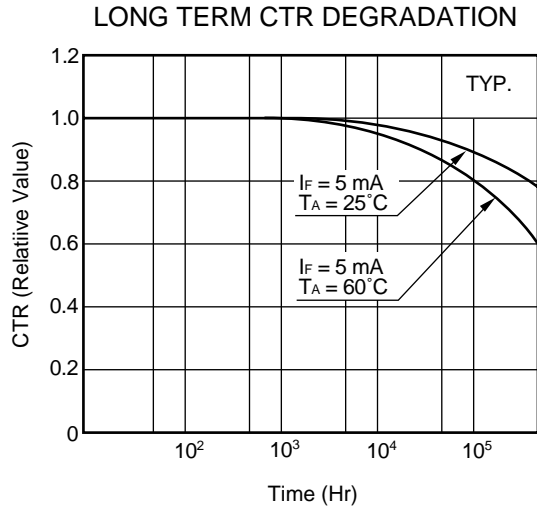
IC, ICEO vs. AMBIENT TEMPERATURE



FREQUENCY RESPONSE



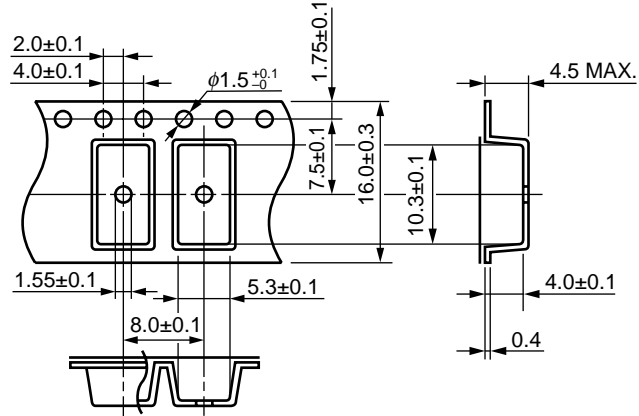
Remark The graphs indicate nominal characteristics.



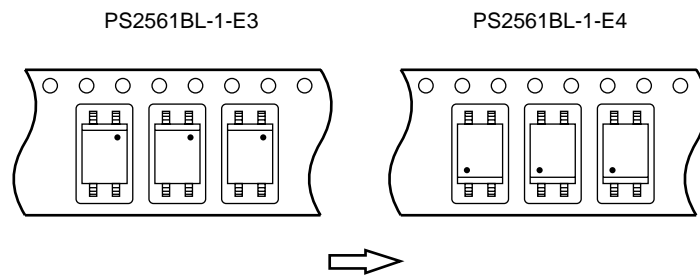
Remark The graph indicates nominal characteristics.

TAPING SPECIFICATIONS (UNIT : mm)

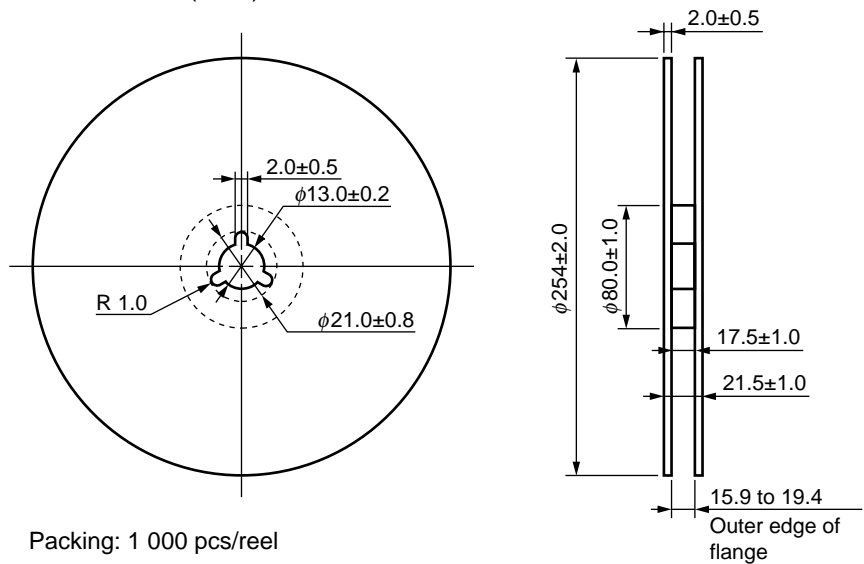
Outline and Dimensions (Tape)



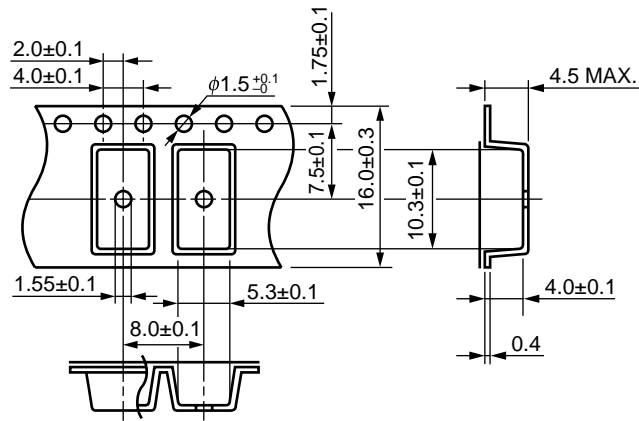
Tape Direction



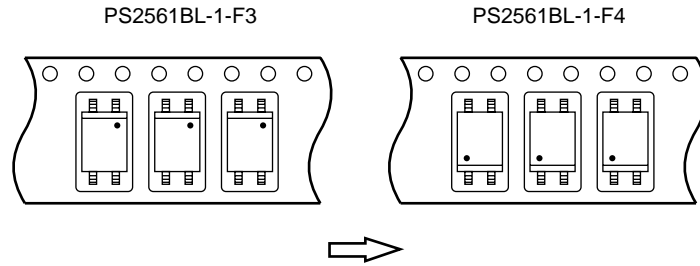
Outline and Dimensions (Reel)



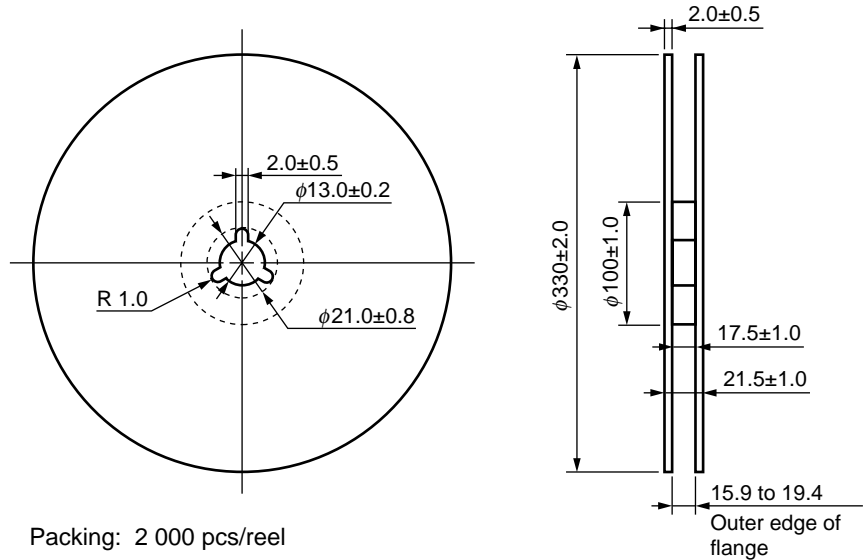
Outline and Dimensions (Tape)



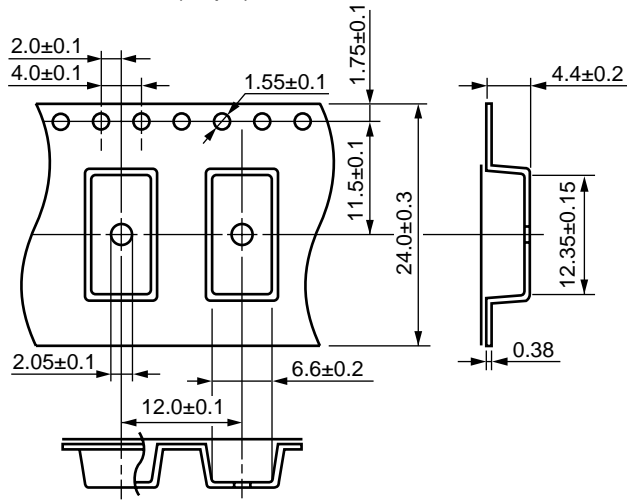
Tape Direction



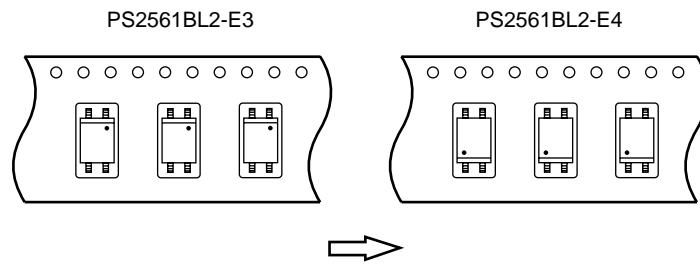
Outline and Dimensions (Reel)



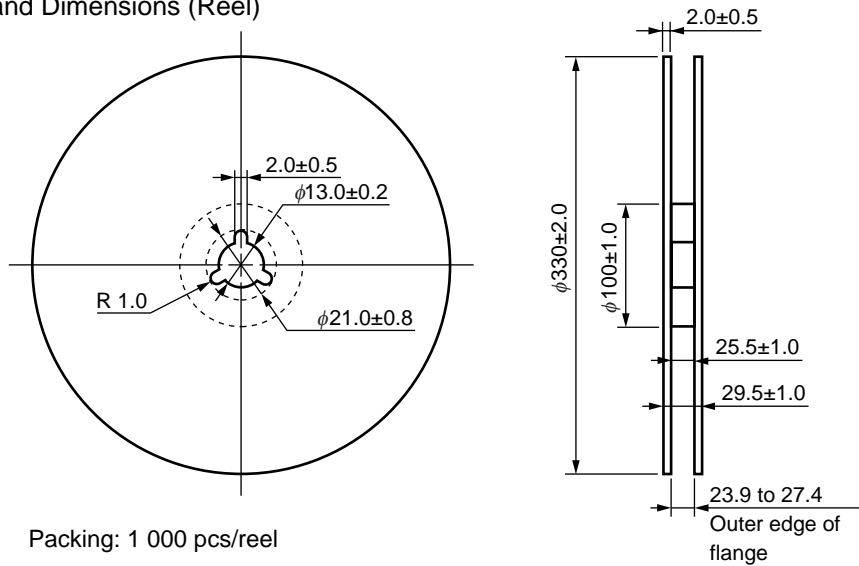
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)



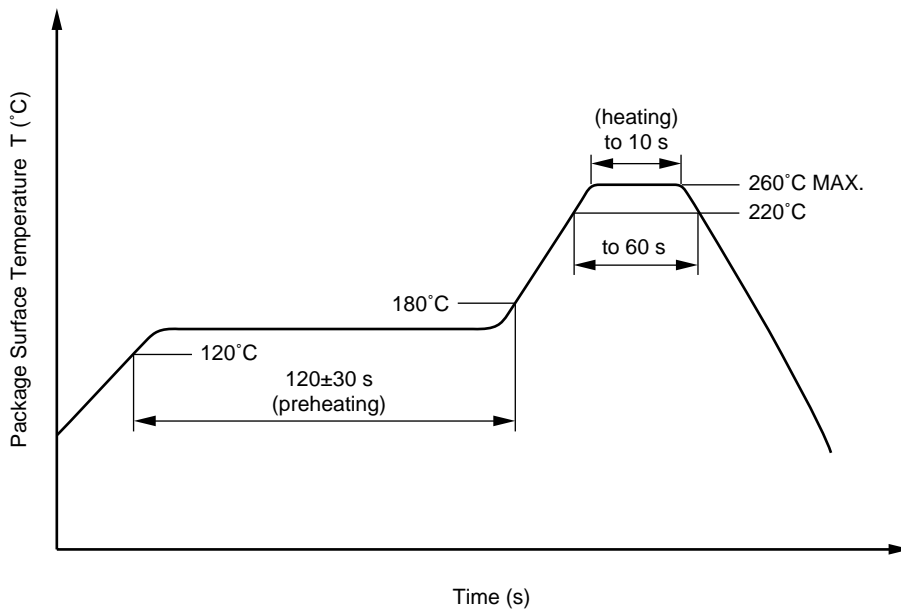
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

- Peak temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between corrector-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL’s understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
		-A	-AZ
Lead (Pb)	< 1000 PPM	Not Detected	(*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

Important Information and Disclaimer: Information provided by CEL on its website or in other communications concerning the substance content of its products represents knowledge and belief as of the date that it is provided. CEL bases its knowledge and belief on information provided by third parties and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. CEL has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. CEL and CEL suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall CEL’s liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

See CEL Terms and Conditions for additional clarification of warranties and liability.

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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